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(5-2008)



Vishay Semiconductors

Silicon PIN Photodiode



LINKS TO ADDITIONAL RESOURCES





DESCRIPTION

VEMD4110X01 is a high speed and high sensitive PIN photodiode. It is a miniature surface mount device (SMD) with a 0.42 mm² sensitive area and a daylight blocking filter matched with IR emitters operating at wavelength of 830 nm to 950 nm.

FEATURES

- Package type: surface-mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.7
- Radiant sensitive area (in mm²): 0.42
- Operating temperature range: T_{OP} = -40 °C to +110 °C
- Daylight blocking filter matched with 830 nm to 950 nm emitters
- Angle of half sensitivity: $\varphi = \pm 55^{\circ}$
- Floor life: 168 h, MSL 3, according to J-STD-020
- · Lead (Pb)-free reflow soldering
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · High speed photo detector
- · Photo interrupters
- Automotive sensors

PRODUCT SUMMARY				
COMPONENT	I_{ra} (μA) at E _e = 1 mW/cm ² , λ = 950 nm, V_R = 5 V	φ (°)	λ _{0.5} (nm)	
VEMD4110X01	2.4	± 55	740 to 1040	

Note

· Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VEMD4110X01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	0805	

Note

MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V _R	20	V
Operating temperature range		T _{amb}	-40 to +110	°C
Storage temperature range		T _{stg}	-40 to +110	°C
Soldering temperature	According to reflow solder profile Fig. 8	T _{sd}	260	°C



BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 50 mA	V _F	-	1.1	1.3	V
Reverse dark current	$V_R = 5 \text{ V}, E = 0$	I _{ro}	-	1	3	nA
Diode capacitance	$V_R = 0 V, f = 1 MHz, E = 0$	C_D	-	7	-	pF
	$V_R = 5 V, f = 1 MHz, E = 0$	C_D	-	2.5	-	pF
Short circuit current	$E_{e} = 1 \text{ mW/cm}^{2}, \lambda = 950 \text{ nm}$	l _k	-	2.2	-	μA
Open circuit voltage	$E_{e} = 1 \text{ mW/cm}^{2}, \lambda = 950 \text{ nm}$	Vo	-	318	-	mV
Temperature coefficient of Ik	$E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$	TK _{lk}	-	0.1	-	%/K
Reverse light current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$, $V_R = 5 \text{ V}$	I _{ra}	1.9	2.4	3.1	μA
Angle of half sensitivity		φ	-	± 55	-	0
Wavelength of peak sensitivity		λ_{p}	-	910	=	nm
Range of spectral bandwidth		λ _{0.5}	-	740 to 1040	-	nm
Rise time	$V_R = 5 \text{ V}, R_L = 1 \text{ k}\Omega, \lambda = 820 \text{ nm}$	t _r	-	100	-	ns
Fall time	$V_R = 5 \text{ V}, R_L = 1 \text{ k}\Omega, \lambda = 820 \text{ nm}$	t _f	-	100	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

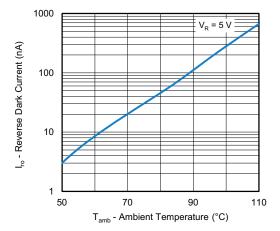


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

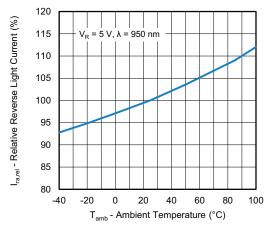


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature



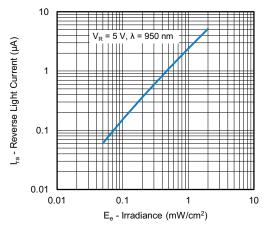


Fig. 3 - Reverse Light Current vs. Irradiance

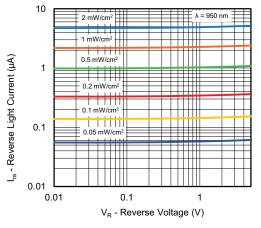


Fig. 4 - Reverse Light Current vs. Reverse Voltage

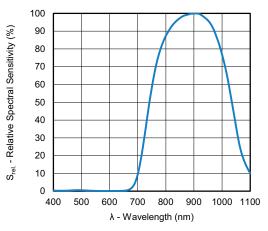


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

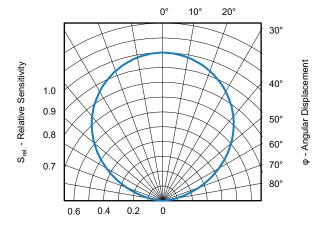


Fig. 6 - Relative Sensitivity vs. Angular Displacement



REFLOW SOLDER PROFILE

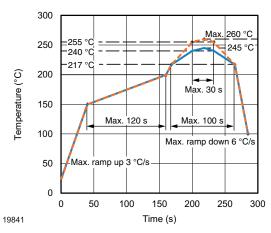


Fig. 7 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

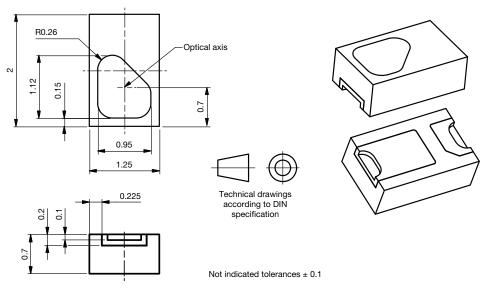
Moisture sensitivity level 3, according to J-STD-020.

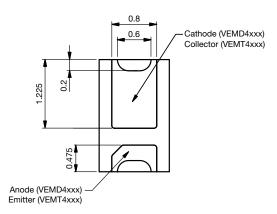
DRYING

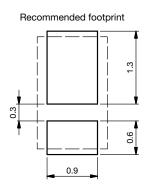
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.



PACKAGE DIMENSIONS in millimeters

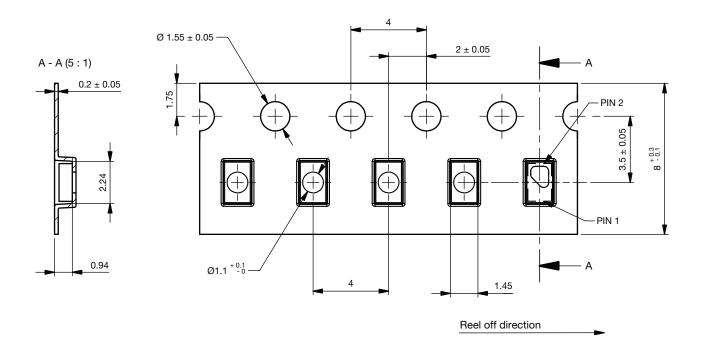






Drawing-No.: 6.550-5363.01-4 Issue: 2; 01.07.2020

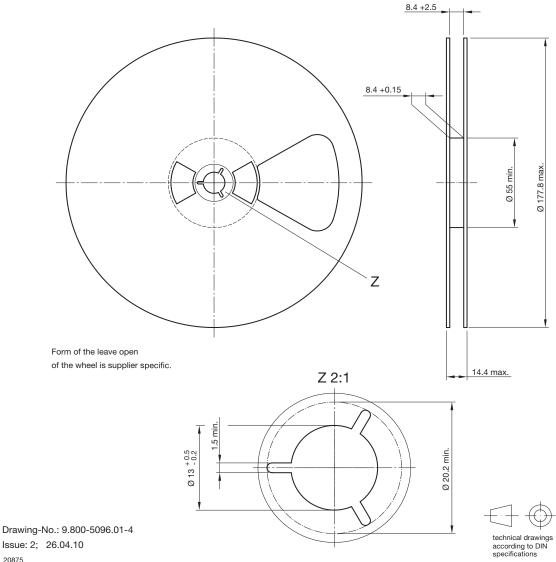
BLISTER TAPE DIMENSIONS in millimeters



TYPE	PIN 1	PIN 2
VEMD4xxx	Anode	Cathode

Drawing-No.: 9.700-5411.0-4 Issue: 1_A; 11.10.2022

REEL DIMENSIONS in millimeters



Issue: 2; 26.04.10

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